



Scholarship Application

DEADLINE: Application must be received by _____ of the year of the award.

Date: ____/____/____

Sponsoring Local Home Builders Association : _____

APPLICATION REQUIREMENTS

1. **Completed** and signed Scholarship Application.
2. Scholarship Applicant must show proof of Admissions Application; or be enrolled in or attending a college, university, junior college or technical/vocational school – current transcript required.
3. A minimum 2.5 GPA or equivalent is required – attach current proof of GPA.
4. One letter of recommendation is required. Recommendation from an HBA member or industry professional is preferred.
5. The Essay portion (Item #3) must be complete. (One-half page minimum; no longer than one page.)

#1 APPLICANT INFORMATION

Full Name: _____
 First Middle Last

Address: _____

Date of Birth: ____/____/____ Social Security Number: ____ - ____ - ____
(SSN is required for the check to be issued.)

Home Phone: (____) ____ - ____ Cell Phone: (____) ____ - ____

Work Phone: (____) ____ - ____ E-mail Address: _____

#2 ACADEMIC INFORMATION

High School: _____
 School Name City State Year of Graduation

Current Enrollment: _____
 School Name City State Anticipated Graduation

Current Status: [] Freshman [] Sophomore [] Junior [] Senior [] Post-Graduate

Degree Program: Major _____ Minor(s) _____

Type of Degree (B.S., B.A., Doctorate, etc.) _____

Honors & Awards: _____

Organizations & Clubs: _____

#3 SHORT ESSAY *(One-half page minimum; no longer than one page, use back of page if necessary.)*

Answer the question, "How will you use your studies in a construction-related field."

#4 BRIEF AUTOBIOGRAPHY *(Include work experience; use back of page if necessary.)*

APPLICANT SIGNATURE & CERTIFICATION OF CONTENT

"I hereby certify that the information contained in this application is true and correct; I authorize the scholarship committee to make such investigation of this application as it deems appropriate, to include the contacting of any of the individuals or institutions referred to in the application. I also give my consent for the transmittal or communication to the scholarship committee by any academic institution that I have attended of grade, class standing or quality point information, as well as information concerning extracurricular activities. I understand that the falsification of any information contained in this application will disqualify me from further consideration or receipt of funds from this scholarship."

Applicant Signature

Date

IF APPLICANT IS UNDER 18 YEARS OF AGE

Parent or Guardian Signature: _____

Address: _____

Phone: ____ / ____ / ____ E-mail: _____

TO BE COMPLETED BY LOCAL HOME BUILDER ASSOCIATION

HBAT FILING DEADLINE: MARCH 1

Board approval date: ____ / ____ / ____ Amount Approved \$ _____ HBAT Matching Fund Request \$ _____

Make check payable to: School or Institution Student

Local HBA President Signature

Date

Local HBA Executive Officer Signature

Date

Revised 7/07